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In The Matter Of
The Insolvency, Restructuring and
Dissolution Act 2018
(Act of 40 of 2018)
And
In The Matter Of
GENOME TECH PTE. LTD.
(Incorporated in the Republic of Singapore)
Reg No. 201841002D
("the Company")

NOTICE OF CREDITORS' MEETING
PURSUANT TO SECTION 166 OF
THE INSOLVENCY, RESTRUCTURING
AND DISSOLUTION ACT 2018 (ACT 40 OF 2018)

NOTICE IS HEREBY GIVEN that pursuant to Section 166 of the Insolvency, Restructuring and Dissolution Act 2018 (Act 40 of 2018), a meeting of the creditors of the abovenamed company will be held by electronic means by way of video conference via Zoom on the 16th day of November 2020 at 3.00 p.m. for the purposes of :-

(a) receiving a statement of the Company's affairs together with a list of creditors and the estimated amounts of their claims;

(b) appointing liquidators;

(c) appointing a committee of inspection of not more than 5 members, if thought fit; and

(d) any other business.

Dated this 4th day of November 2020

By order of the Board
Honda Junsuke
Director

Attendance by video conference:

(1) In compliance with the COVID-19 (Temporary Measures) Act 2020 and the COVID-19 (Temporary Measures) (Alternative Arrangements for Meetings) (Corporate Insolvency) Order 2020, creditors may attend the above meeting by way of video conference via Zoom by submitting a General or Special Proxy form and including the details of one attendee to us by way of email to: zhaoencao@ardent.com.sg not later than 4 p.m. on the day before the meeting.

(2) If you are appointing the Liquidator as your proxy, please submit your Special Proxy form with your vote(s) indicated in relation to the proposed resolution(s), if any, by not later than 4 p.m. on the day before the meeting.

(3) Creditors may send any questions or other substantial and relevant matters that the creditors wish to raise at the meeting by way of email to the above email addresses by not later than 4 p.m. two (2) days before the meeting.